STW56N65DM2

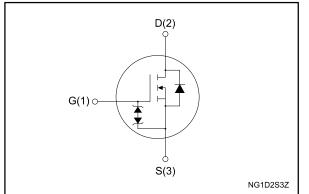
Datasheet - production data



N-channel 650 V, 0.058 Ω typ., 48 A MDmesh[™] DM2 Power MOSFET in a TO-247 package

TO-247

Figure 1: Internal schematic diagram



This is information on a product in full production.

Features

Order code	V _{DS}	R _{DS(on)} max.	ID	Ртот
STW56N65DM2	650 V	0.065 Ω	48 A	360 W

- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

Applications

• Switching applications

Description

This high voltage N-channel Power MOSFET is part of the MDmesh[™] DM2 fast recovery diode series. It offers very low recovery charge (Qrr) and time (trr) combined with low R_{DS(on)}, rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STW56N65DM2	56N65DM2	TO-247	Tube

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±25	V
1-	Drain current (continuous) at T _{case} = 25 °C	48	٨
lo	Drain current (continuous) at T _{case} = 100 °C	30	A
IDM ⁽¹⁾	Drain current (pulsed) 15		А
P _{TOT}	Total dissipation at $T_{case} = 25 \text{ °C}$ 3		W
dv/dt ⁽²⁾	Peak diode recovery voltage slope 50		\//no
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50 V/ns	
T _{stg}	Storage temperature		°C
Tj	Operating junction temperature	-55 to 150	C

Notes:

 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ I_{SD} ≤ 48 A, di/dt= 900 A/µs; V_{DS} peak < V_{(BR)DSS}, V_DD = 400 V

⁽³⁾ $V_{DS} \le 520 \text{ V}.$

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj} -case	Thermal resistance junction-case	0.35	°C / / /
R _{thj-amb}	Thermal resistance junction-ambient	50	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
lar	Avalanche current, repetitive or not repetitive	7	А
Eas ⁽¹⁾	Single pulse avalanche energy	1300	mJ

Notes:

 $^{(1)}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.



2 **Electrical characteristics**

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	650			V
	Zoro goto voltago droin	$V_{GS} = 0 V, V_{DS} = 650 V$			10	
IDSS Zero gate voltage drain current	$V_{GS} = 0 V$, $V_{DS} = 650 V$, $T_{case} = 125 $ °C			100	μA	
Igss	Gate-body leakage current	$V_{DS} = 0 V$, $V_{GS} = \pm 25 V$			±5	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 24 \text{ A}$		0.058	0.065	Ω

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	4100	-	
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	160	-	рF
Crss	Reverse transfer capacitance	$V_{GS} = 0 V$	-	2.5	-	p.
Coss eq. ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 to 520 V, V_{GS} = 0 V	-	375	-	pF
R_G	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	4.1	-	Ω
Qg	Total gate charge	V _{DD} = 520 V, I _D = 48 A,	-	88	-	
Q _{gs}	Gate-source charge	V _{GS} = 10 V (see Figure 15: "Test circuit for gate charge	-	22	-	nC
Q_{gd}	Gate-drain charge	behavior")	-	37	-	

Table 6: Dynamic

Notes:

 $^{(1)}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DSS}.

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 325 \text{ V}, I_D = 24 \text{ A}$	-	28	-	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Test circuit for	-	31	-	
t _{d(off)}	Turn-off delay time	resistive load switching	-	157	-	ns
tr	Fall time	times" and Figure 19: "Switching time waveform")	-	7.7	-	

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Electrical characteristics

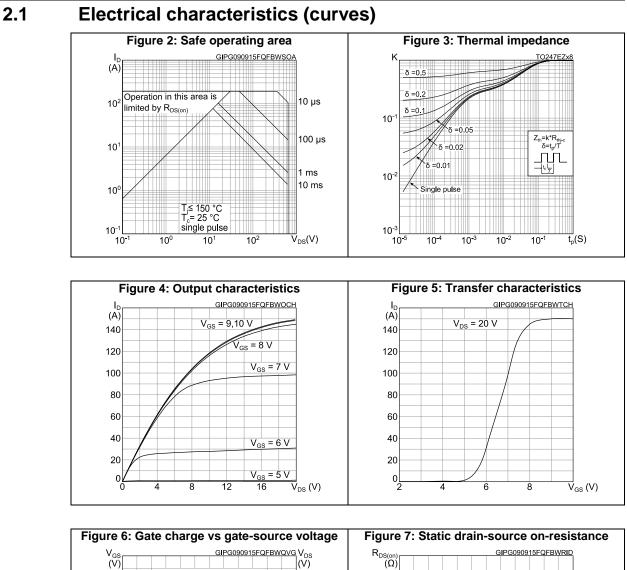
Table 8: Source-drain diode						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		48	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		192	А
Vsd ⁽²⁾	Forward on voltage	$V_{GS} = 0 V, I_{SD} = 48 A$	-		1.6	V
trr	Reverse recovery time	I _{SD} = 48 A, di/dt = 100 A/µs,	-	135		ns
Qrr	Reverse recovery charge	V _{DD} = 100 V (see Figure 16: "Test circuit for inductive	-	0.68		μC
I _{RRM}	Reverse recovery current	load switching and diode recovery times")	-	10		А
trr	Reverse recovery time	I _{SD} = 48 A, di/dt = 100 A/µs,	-	260		ns
Qrr	Reverse recovery charge	$V_{DD} = 100 \text{ V}, \text{ T}_{\text{j}} = 150 ^{\circ}\text{C}$ (see Figure 16: "Test circuit	-	2.75		μC
Irrm	Reverse recovery current	for inductive load switching and diode recovery times")	-	21		A

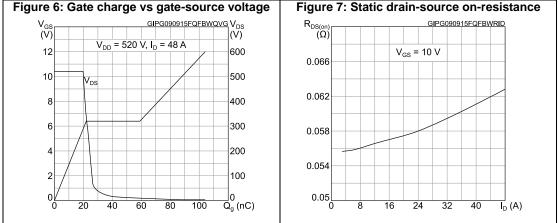
Notes:

 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.





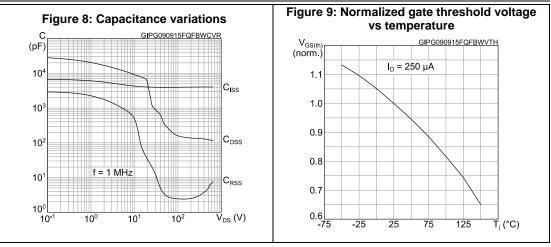


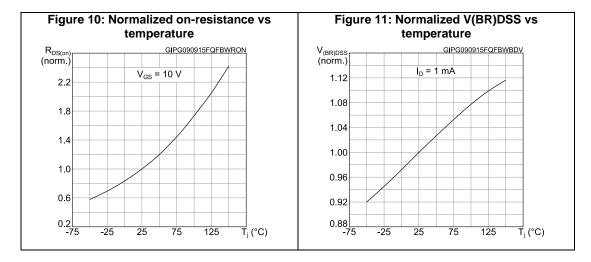
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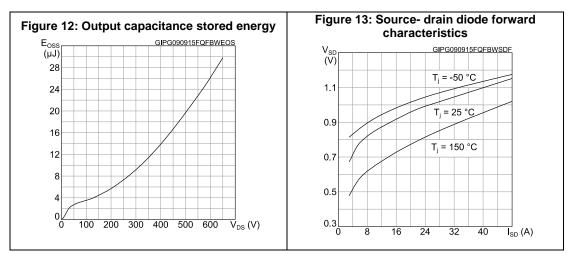
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Electrical characteristics

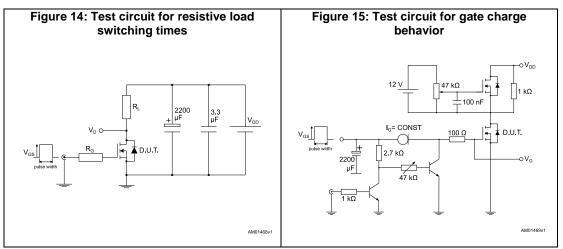


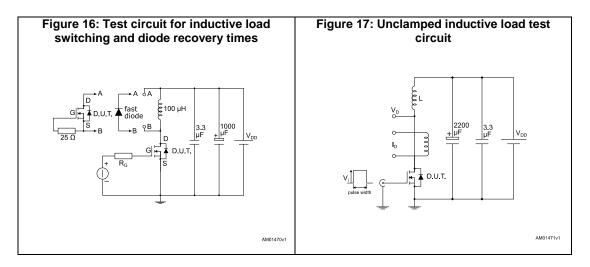


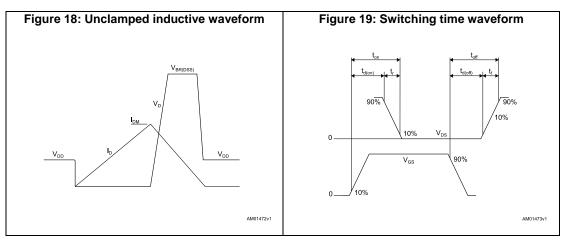


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3 Test circuits







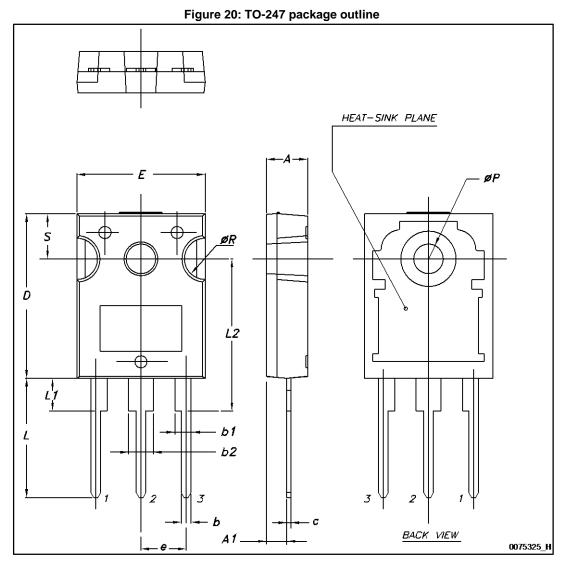
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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247 package information





Package information

Table 9: TO-247 package mechanical data

STW56N65DM2

Table 9: 10-247 package mechanical data			
Dim.		mm.	
Dini.	Min.	Тур.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

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5 Revision history

Table 10: Document revision history

Date	Revision	Changes
27-Nov-2014	1	First release.
15-Sep-2015	2	 Text and formatting changes throughout document. In section <i>Electrical ratings</i>: updated tables <i>Absolute maximum ratings</i> and <i>Avalanche characteristics</i> In section <i>Electrical characteristics</i>: updated and renamed table <i>Static</i> (was On/off states) updated tables <i>Dynamic</i>, <i>Switching times</i> and <i>Source-drain diode</i> Updated section <i>Electrical characteristics</i> (curves)



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